

Initial Information Data Sheet

Inventor Information

Inventor One Given Name:: Roy
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Inventor Two Given Name:: Andrej
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Correspondence Information

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Application Information

Title Line One:: PRODUCTION OF SEMICONDUCTOR SUBSTRATES
Title Line Two:: WITH BURIED LAYERS BY JOINING (BONDING)
Title Line Three:: SEMICONDUCTOR WAFERS
Total Drawing Sheets:: 1
Formal Drawings?:: Yes
Application Type:: Utility
Docket Number:: LEO 003 PA

Representative Information

Customer No.:: 29673

Prior Foreign Applications

Foreign Application One:: 103 55 728.8
Filing Date:: 11/28/2003
Country:: DE
Priority Claimed:: Yes